● **Bidirectional Bus Transceivers in High-Density 20-Pin Packages**

● **Lower-Power Versions of SN74ALS640B and SN74ALS645A**

● **Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs**

DW OR N PACKAGE
(TOP VIEW)

|			
DIR	1	20	V_{CC}
A1	2	19	$\overline{OE}$
A2	3	18	B1
A3	4	17	B2
A4	5	16	B3
A5	6	15	B4
A6	7	14	B5
A7	8	13	B6
A8	9	12	B7
GND	10	11	B8
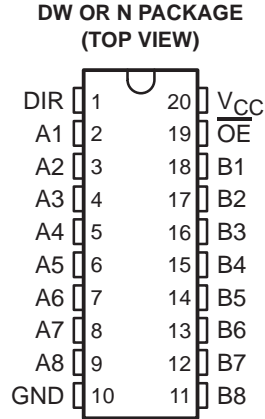
description

These octal bus transceivers are designed for asynchronous two-way communication between data buses. These devices transmit data from the A bus to the B bus or from the B bus to the A bus, depending on the level at the direction-control (DIR) input. The output-enable ($\overline{OE}$) input can be used to disable the device so that the buses are effectively isolated. The SN74ALS1640A features inverting logic, while the SN74ALS1645A features noninverting logic.

The SN74ALS1640A and SN74ALS1645A are characterized for operation from 0°C to 70°C.

FUNCTION TABLE

INPUTS		OPERATION	
$\overline{OE}$	DIR	SN74ALS1640A	SN74ALS1645A
L	L	$\overline{B}$ data to A bus	B data to A bus
L	H	$\overline{A}$ data to B bus	A data to B bus
H	X	Isolation	Isolation

logic symbols[†]

SN74ALS1640A

SN74ALS1645A
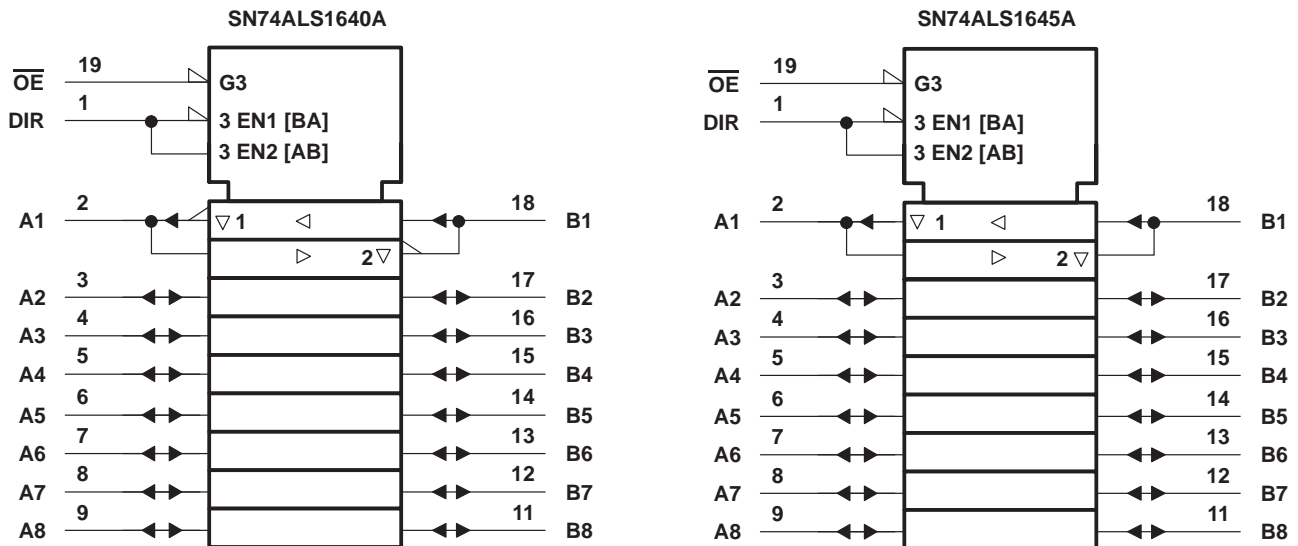
[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagrams (positive logic)

SN74ALS1640A

SN74ALS1645A

To Seven Other Transceivers

To Seven Other Transceivers
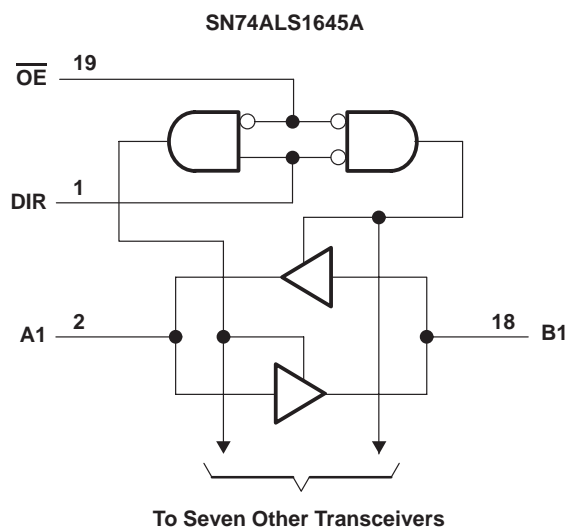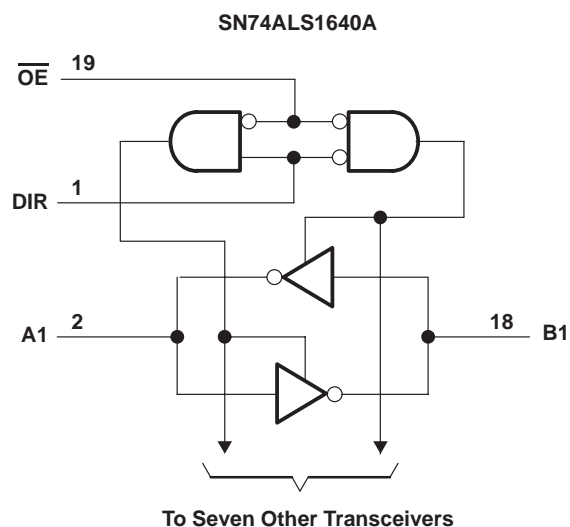
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . 7 V
Input voltage, V_I: All inputs . . . . 7 V
I/O ports . . . . 5.5 V
Package thermal impedance, θ_{JA} (see Note 1): DW package . . . . 97°C/W
N package . . . . 67°C/W
Storage temperature range, T_{stg} . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
  functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
  implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTE 1:   The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which
          use a trace length of zero.

recommended operating conditions

		SN74ALS1640A SN74ALS1645A			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
I_{OH}	High-level output current			−15	mA
I_{OL}	Low-level output current			16	mA
T_A	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN74ALS1640A SN74ALS1645A			UNIT
				MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = −18 mA			−1.5	V
V_{OH}		V_{CC} = 4.5 V to 5.5 V,	I_{OH} = −0.4 mA	V_{CC}−2			V
		V_{CC} = 4.5 V	I_{OH} = −3 mA	2.4	3.2		
			I_{OH} = −15 mA	2			
V_{OL}		V_{CC} = 4.5 V	I_{OL} = 8 mA		0.25	0.4	V
			I_{OL} = 16 mA		0.35	0.5	
I_I	Control inputs	V_{CC} = 5.5 V	V_I = 7 V			0.1	mA
	A or B ports		V_I = 5.5 V			0.1	
I_{IH}	Control inputs	V_{CC} = 5.5 V,	V_I = 2.7 V			20	µA
	A or B ports‡					20	
I_{IL}	Control inputs	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.1	mA
	A or B ports‡					−0.1	
I_O§		V_{CC} = 5.5 V,	V_O = 2.25 V	−30		−112	mA
I_{CC}	SN74ALS1640A	V_{CC} = 5.5 V			18	32	mA
	SN74ALS1645A	V_{CC} = 5.5 V			25	38	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.
§ The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS}.
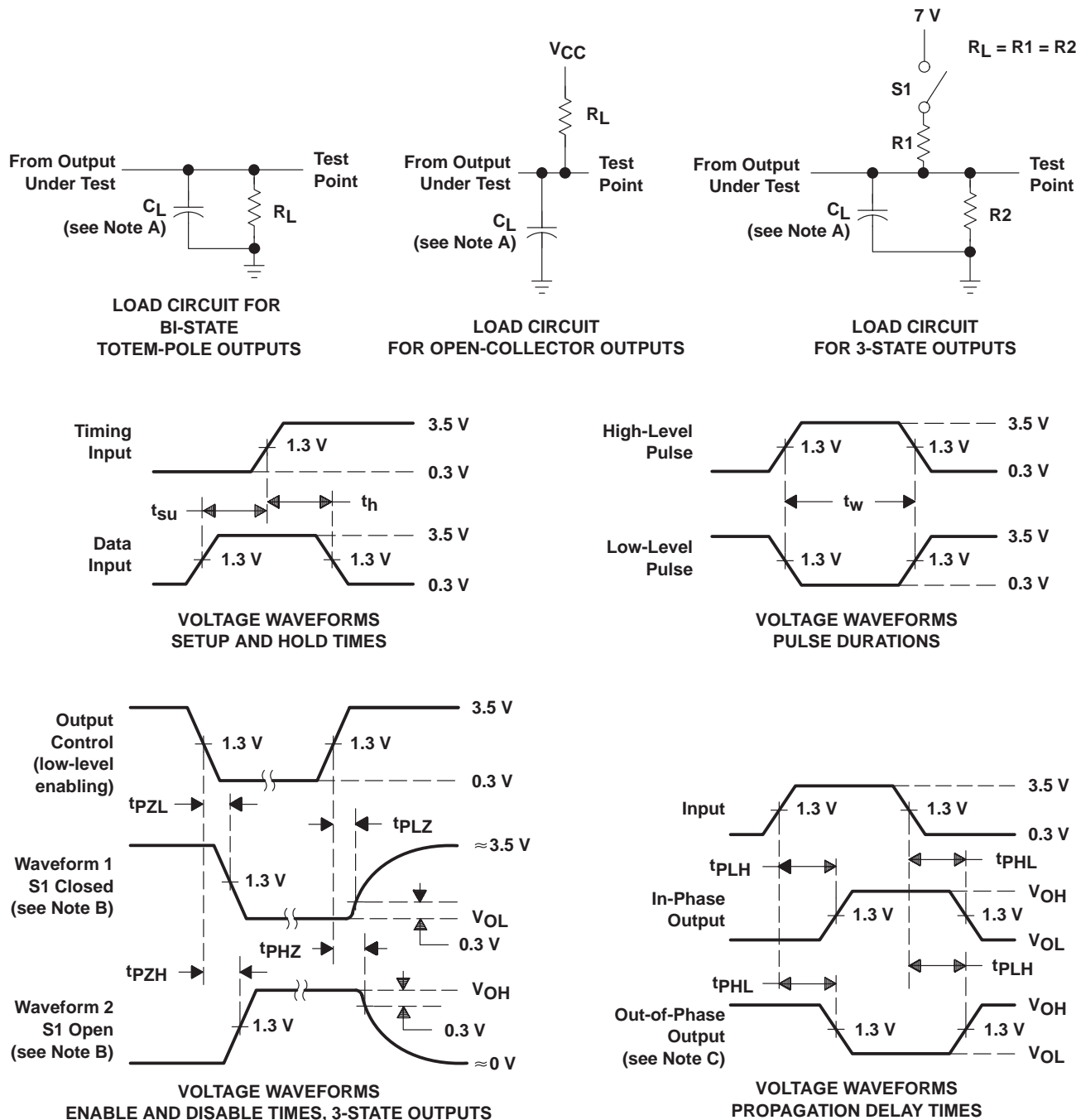
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAX¶				UNIT
			SN74ALS1640A		SN74ALS1645A		
			MIN	MAX	MIN	MAX	
t_{PLH}	A or B	B or A	4	15	2	13	ns
t_{PHL}			2	10	2	13	
t_{PZH}	$\overline{OE}$	A or B	5	20	8	25	ns
t_{PZL}			5	22	8	25	
t_{PHZ}	$\overline{OE}$	A or B	2	10	2	12	ns
t_{PLZ}			5	13	3	18	

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

TEXAS
INSTRUMENTS

PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES

**LOAD CIRCUIT FOR
BI-STATE
TOTEM-POLE OUTPUTS**

**LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS**

**LOAD CIRCUIT
FOR 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PULSE DURATIONS**

**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**

NOTES: A. C_L includes probe and jig capacitance.
        B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
           Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
        C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
        D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f$ = 2 ns, duty cycle = 50%.
        E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS1645AN	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS1645AN	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

TUBE

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ALS1645AN	N	PDIP	20	20	506	13.97	11230	4.32

N (R−PDIP−T**)
16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE

DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

A

16   9

0.260 (6,60)
0.240 (6,10)

1   8

0.070 (1,78)
0.045 (1,14)

0.045 (1,14)
0.030 (0,76)

0.020 (0,51) MIN

0.325 (8,26)
0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.010 (0,25) NOM

0.100 (2,54)

0.021 (0,53)
0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

0.430 (10,92) MAX

14/18 Pin Only
20 Pin vendor option

4040049/E   12/2002

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
         C. Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
         D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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